

S3ABF THRU S3MBF
General Purpose Rectifiers



Voltage: 50~1000 Volts

Current: 3 Amperes

Polarity And Marking

Package: SMBF

Features

- NH'S Standard Rectifier Chip Technology
- Low Forward Voltage Drop For High Efficiency
- Low Leakage Current For High Reliability
- High Surge Capability For High Reliability

Mechanical Data

- **Case:** Molded With UL-94 Class V-0 Recognized, RoHS-Compliant
- **Polarity:** Look At The Polarity And Marking On The Right
- **Terminals:** Tin Plated Leads, Solderable Per J-STD-002 And JESD22-B102
- **Weight:** App. 0.095 Grams (0.003351 Ounce)

Typical Applications

- Switch Mode Power Supplies (SMPS)
- Fast Chargers
- LED Driver And Monitor Lighting
- Automotive Electronics And Charging Posts



Remark:

- ①. NH=Niuhang Trademark
- ②. FF=Product Line Code, According To Actual Changes
YWW=Date Code, According To Actual Changes
- ③. S3xBF=Model, x=A,B,D,G,J,K,M
- ④. White band denotes cathode

Single Phase, Half Wave, 60Hz, Resistive Or Inductive Load. For Capacitive Load, Derate Current By 20%

Maximum Ratings (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	S3 ABF	S3 BBF	S3 DBF	S3 GBF	S3 JBF	S3 KBF	S3 MBF	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage		V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage		V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current	@TC= 100 °C	$I_{F(AV)}$	3							A
Peak Forward Surge Current	8.3ms Single Half Sine-wave Superimposed On Rate Load	I_{FSM}	100							A
Current Squared Time	t< 8.3 ms	I^2t	41.5							A ² sec

Electrical Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	S3 ABF	S3 BBF	S3 DBF	S3 GBF	S3 JBF	S3 KBF	S3 MBF	Unit
Maximum Instantaneous Forward Voltage	$I_F = 3.0 A$	V_F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	Ta=25°C $V_R = V_{RRM}$ Ta=125°C $V_R = V_{RRM}$	I_{RRM}	5 200							uA uA
Typical Junction Capacitance	4 V, 1MHz	C_J	25							pF

Thermal Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	S3 ABF	S3 BBF	S3 DBF	S3 GBF	S3 JBF	S3 KBF	S3 MBF	Unit
Operating Junction Temperature Range		T _J	-55 to 150							°C
Storage Temperature Range		T _{STD}	-55 to 150							
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25°C	R _{θJA}	52							°C/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 1 in2 FR-4 Board With 2oz. Copper	R _{θJC}	10							

Notes: 1. Pulse Test: 300 Us Pulse Width, 1% Duty Cycle

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Typical Characteristics Curves

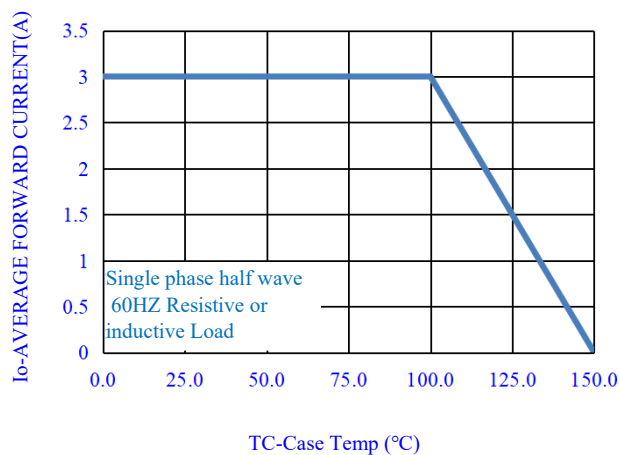


Fig.1-FORWARD CURRENT DERATING CURVE

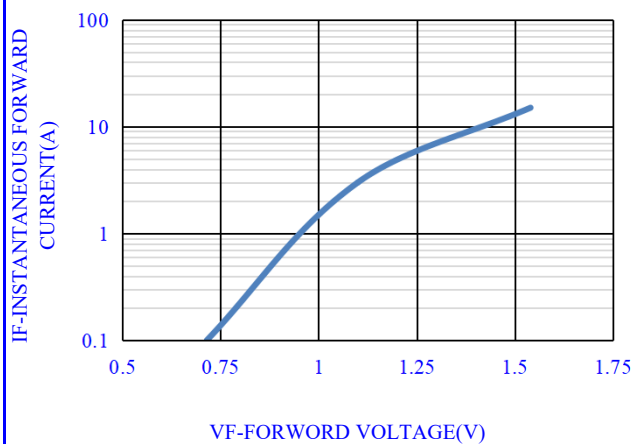


Fig.2- TYPICAL INSTANTANEOUS FORWARD

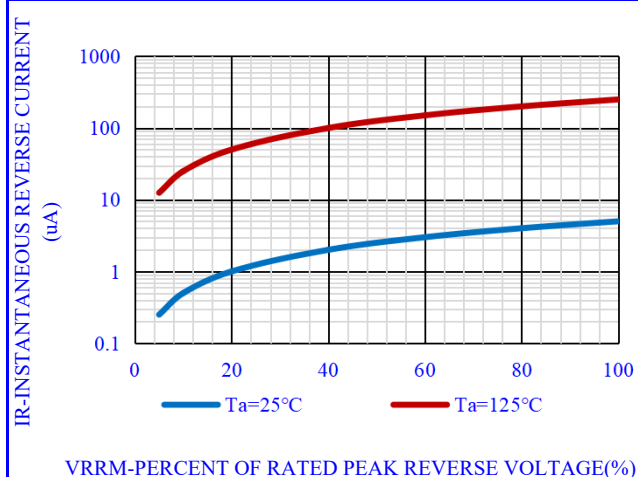


Fig.3- TYPICAL REVERSE CHARACTERISTICS

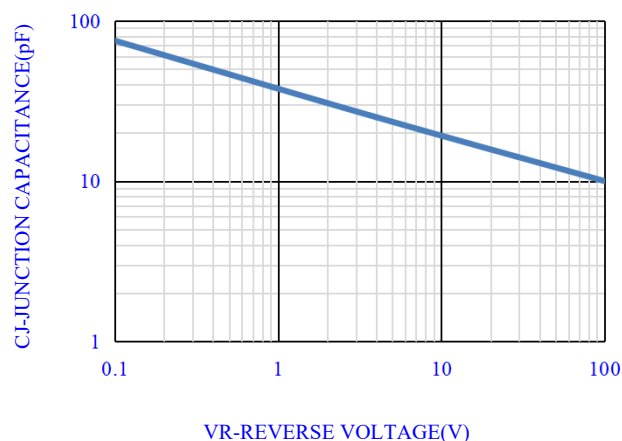


Fig.4- TYPICAL JUNCTION CAPACITANCE

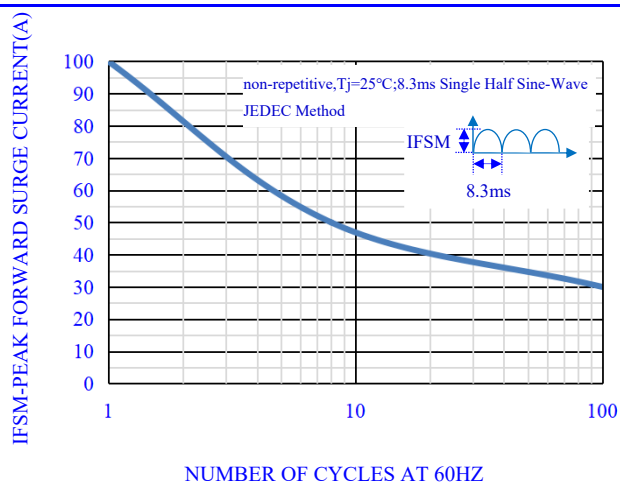
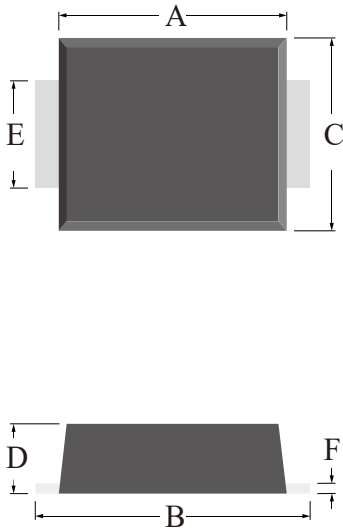


Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

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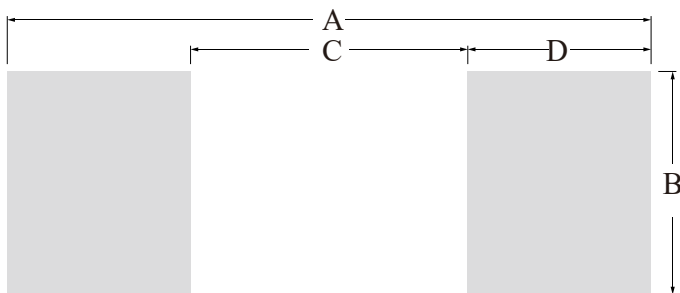
OUTLINE DRAWINGS



SMBF

OUTLINE DIMENSIONS						
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.10	-	4.70	0.1614	-	0.1850
B	5.10	-	5.50	0.2008	-	0.2165
C	3.40	-	3.80	0.1339	-	0.1496
D	1.05	-	1.55	0.0413	-	0.0610
E	1.80	-	2.20	0.0709	-	0.0866
F	0.13	-	0.25	0.0051	-	0.0098
G	0.55	-	1.45	0.0217	-	0.0571

RECOMMENDED LAYOUT DRAWINGS



SMBF

OUTLINE DIMENSIONS						
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	6.50	-	-	0.2559	-
B	-	2.20	-	-	0.0866	-
C	-	2.80	-	-	0.1102	-
D	-	1.85	-	-	0.0728	-

PACKING INFORMATION

Package Code	Package Method	Min. Pack. Size (mm)	Quantity (Pcs/Min. Pack.)	Inner Box Size L×W×H(mm)	Quantity (Pcs/Inner Box)	Outer Carton Size L×W×H(mm)	Quantity (Pcs/Carton)
SMBF	T/R	Φ330	3000	340×340×42	6000	365x365x360	48000

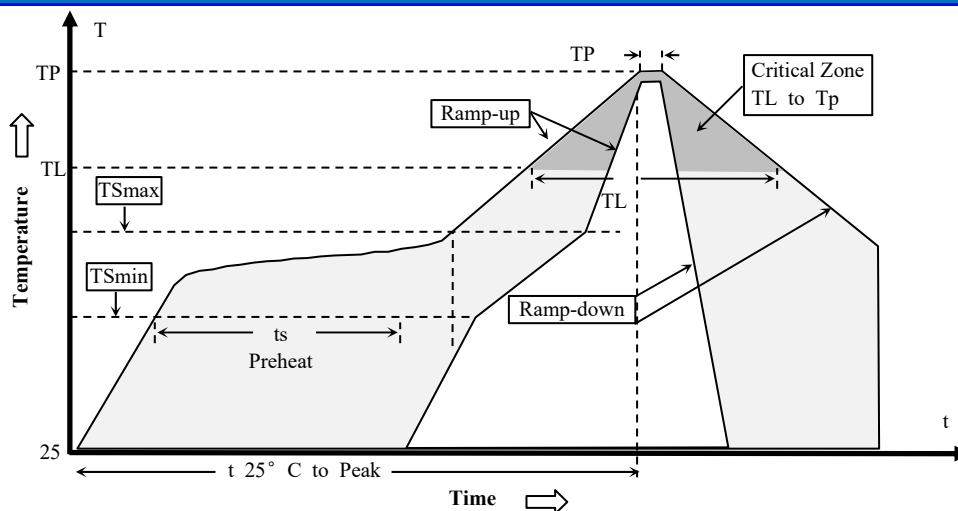
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(T _S min) -Temperature Max(T _S max) -Time(t _s min to t _s max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (T _L) - Time (t _L)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(T _P)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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